

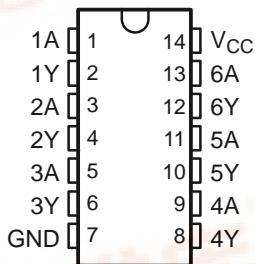
FEATURES

- Operate From 1.65 V to 3.6 V
- Specified From -40°C to 85°C, -40°C to 125°C, and -55°C to 125°C
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 6.4 ns at 3.3 V
- Typical V_{OLP} (Output Ground Bounce) < 0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$

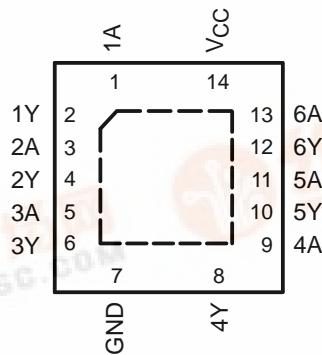
- Typical V_{OHV} (Output V_{OH} Undershoot) > 2 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

SN54LVC14A ... J OR W PACKAGE
SN74LVC14A ... D, DB, DGV, NS,

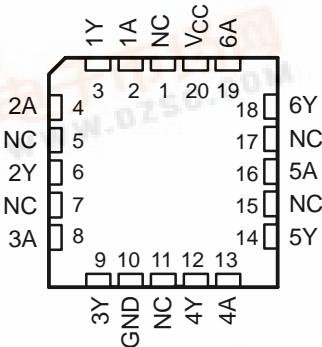
OR PW PACKAGE
(TOP VIEW)



SN74LVC14A ... RGY PACKAGE
(TOP VIEW)



SN54LVC14A ... FK PACKAGE
(TOP VIEW)



NC - No internal connection

DESCRIPTION/ORDERING INFORMATION

The SN54LVC14A hex Schmitt-trigger inverter is designed for 2.7-V to 3.6-V V_{CC} operation, and the SN74LVC14A hex Schmitt-trigger inverter is designed for 1.65-V to 3.6-V V_{CC} operation.

ORDERING INFORMATION

T _A	PACKAGE ⁽¹⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	QFN – RGY	Reel of 1000	SN74LVC14ARGYR
-40°C to 125°C	SOIC – D	Tube of 50	SN74LVC14AD
		Reel of 2500	SN74LVC14ADR
		Reel of 250	SN74LVC14ADT
	SOP – NS	Reel of 2000	SN74LVC14ANSR
	SSOP – DB	Reel of 2000	SN74LVC14ADBR
	TSSOP – PW	Tube of 90	SN74LVC14APW
		Reel of 2000	SN74LVC14APWR
		Reel of 250	SN74LVC14APWT
-55°C to 125°C	TVSOP – DGV	Reel of 2000	SN74LVC14ADGVR
	CDIP – J	Tube of 25	SNJ54LVC14AJ
	CFP – W	Tube of 150	SNJ54LVC14AW
	LCCC – FK	Tube of 55	SNJ54LVC14AFK

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

SN54LVC14A, SN74LVC14A HEX SCHMITT-TRIGGER INVERTERS

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DESCRIPTION/ORDERING INFORMATION (CONTINUED)

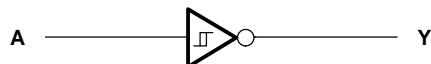
The devices contain six independent inverters and perform the Boolean function $Y = \bar{A}$.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of these devices as translators in a mixed 3.3-V/5-V system environment.

**FUNCTION TABLE
(EACH INVERTER)**

INPUT A	OUTPUT Y
H	L
L	H

logic diagram, each inverter (positive logic)



Absolute Maximum Ratings ⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
V_{CC}	Supply voltage range	-0.5	6.5	V
V_I	Input voltage range ⁽²⁾	-0.5	6.5	V
V_O	Output voltage range ⁽²⁾⁽³⁾	-0.5	$V_{CC} + 0.5$	V
I_{IK}	Input clamp current	$V_I < 0$	-50	mA
I_{OK}	Output clamp current	$V_O < 0$	-50	mA
I_O	Continuous output current		± 50	mA
	Continuous current through V_{CC} or GND		± 100	mA
θ_{JA}	Package thermal impedance	D package ⁽⁴⁾	86	°C/W
		DB package ⁽⁴⁾	96	
		DGV package ⁽⁴⁾	127	
		NS package ⁽⁴⁾	76	
		PW package ⁽⁴⁾	113	
		RGY package ⁽⁵⁾	47	
T_{stg}	Storage temperature range	-65	150	°C
P_{tot}	Power dissipation	$T_A = -40^\circ\text{C}$ to 125°C ⁽⁶⁾⁽⁷⁾		
			500	mW

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
- (3) The value of V_{CC} is provided in the recommended operating conditions table.
- (4) The package thermal impedance is calculated in accordance with JESD 51-7.
- (5) The package thermal impedance is calculated in accordance with JESD 51-5.
- (6) For the D package: above 70°C , the value of P_{tot} derates linearly with 8 mW/K .
- (7) For the DB, DGV, NS, and PW packages: above 60°C , the value of P_{tot} derates linearly with 5.5 mW/K .

Recommended Operating Conditions⁽¹⁾

				SN54LVC14A	UNIT		
				-55 TO 125°C			
				MIN MAX			
V_{CC}		Supply voltage		Operating	2 3.6		
				Data retention only	1.5		
V_I	Input voltage			0 5.5	V		
V_O	Output voltage			0 V_{CC}	V		
I_{OH}		High-level output current		$V_{CC} = 2.7\text{ V}$	-12		
				$V_{CC} = 3\text{ V}$	-24		
I_{OL}		Low-level output current		$V_{CC} = 2.7\text{ V}$	12		
				$V_{CC} = 3\text{ V}$	24		

- (1) All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

Recommended Operating Conditions⁽¹⁾

		SN74LVC14A						UNIT	
		$T_A = 25^\circ\text{C}$		$-40 \text{ TO } 85^\circ\text{C}$		$-40 \text{ TO } 125^\circ\text{C}$			
		MIN	MAX	MIN	MAX	MIN	MAX		
V_{CC}	Supply voltage	Operating	1.65	3.6	1.65	3.6	1.65	3.6	
		Data retention only	1.5		1.5		1.5		
V_I	Input voltage		0	5.5	0	5.5	0	5.5	
V_O	Output voltage		0	V_{CC}	0	V_{CC}	0	V_{CC}	
I_{OH}	High-level output current	$V_{CC} = 1.65\text{ V}$		-4		-4		mA	
		$V_{CC} = 2.3\text{ V}$		-8		-8			
		$V_{CC} = 2.7\text{ V}$		-12		-12			
		$V_{CC} = 3\text{ V}$		-24		-24			
I_{OL}	Low-level output current	$V_{CC} = 1.65\text{ V}$		4		4		mA	
		$V_{CC} = 2.3\text{ V}$		8		8			
		$V_{CC} = 2.7\text{ V}$		12		12			
		$V_{CC} = 3\text{ V}$		24		24			

- (1) All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

SN54LVC14A, SN74LVC14A HEX SCHMITT-TRIGGER INVERTERS

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Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	SN54LVC14A			UNIT	
			-55 TO 125°C				
			MIN	TYP	MAX		
V _{T+} Positive-going threshold		2.7 V	0.8	2		V	
		3 V	0.9	2			
		3.6 V	1.1	2			
V _{T-} Negative-going threshold		2.7 V	0.4	1.4		V	
		3 V	0.6	1.5			
		3.6 V	0.8	1.7			
ΔV _T Hysteresis (V _{T+} – V _{T-})		2.7 V	0.3	1.1		V	
		3 V	0.3	1.2			
		3.6 V	0.3	1.2			
V _{OH}	I _{OH} = -100 μA	2.7 V to 3.6 V	V _{CC} – 0.2			V	
	I _{OH} = -12 mA	2.7 V	2.2				
	I _{OH} = -24 mA	3 V	2.4				
V _{OL}	I _{OL} = 100 μA	2.7 V to 3.6 V		0.2		V	
	I _{OL} = 12 mA	2.7 V		0.4			
	I _{OL} = 24 mA	3 V		0.55			
I _I	V _I = 5.5 V or GND	3.6 V		±5	μA		
I _{CC}	V _I = V _{CC} or GND, I _O = 0	3.6 V		10	μA		
ΔI _{CC}	One input at V _{CC} – 0.6 V, Other inputs at V _{CC} or GND	2.7 V to 3.6 V		500	μA		
C _i	V _I = V _{CC} or GND	3.3 V		5 ⁽¹⁾	pF		

(1) T_A = 25°C

Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	SN74LVC14A						UNIT	
			T _A = 25°C			−40 TO 85°C		−40 TO 125°C		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V _{T+} Positive-going threshold		1.65 V	0.4	1.3	0.4	1.3	0.4	1.3		V
		1.95 V	0.6	1.5	0.6	1.5	0.6	1.5		
		2.3 V	0.8	1.7	0.8	1.7	0.8	1.7		
		2.5 V	0.8	1.7	0.8	1.7	0.8	1.7		
		2.7 V	0.8	2	0.8	2	0.8	2		
		3 V	0.9	2	0.9	2	0.9	2		
		3.6 V	1.1	2	1.1	2	1.1	2		
V _{T−} Negative-going threshold		1.65 V	0.15	0.85	0.15	0.85	0.15	0.85		V
		1.95 V	0.25	0.95	0.25	0.95	0.25	0.95		
		2.3 V	0.4	1.2	0.4	1.2	0.4	1.2		
		2.5 V	0.4	1.2	0.4	1.2	0.4	1.2		
		2.7 V	0.4	1.4	0.4	1.4	0.4	1.4		
		3 V	0.6	1.5	0.6	1.5	0.6	1.5		
		3.6 V	0.8	1.7	0.8	1.7	0.8	1.7		
ΔV_T Hysteresis (V _{T+} − V _{T−})		1.65 V	0.1	1.15	0.1	1.15	0.1	1.15		V
		1.95 V	0.15	1.25	0.15	1.25	0.15	1.25		
		2.3 V	0.25	1.3	0.25	1.3	0.25	1.3		
		2.5 V	0.25	1.3	0.25	1.3	0.25	1.3		
		2.7 V	0.3	1.1	0.3	1.1	0.3	1.1		
		3 V	0.3	1.2	0.3	1.2	0.3	1.2		
		3.6 V	0.3	1.2	0.3	1.2	0.3	1.2		
V _{OH}	I _{OH} = −100 µA	1.65 V to 3.6 V	V _{CC} − 0.2		V _{CC} − 0.2	V _{CC} − 0.3				V
	I _{OH} = −4 mA	1.65 V	1.29		1.2	1.05				
	I _{OH} = −8 mA	2.3 V	1.9		1.7	1.65				
	I _{OH} = −12 mA	2.7 V	2.2		2.2	2.05				
	I _{OH} = −24 mA	3 V	2.4		2.4	2.25				
	I _{OH} = −24 mA	3 V	2.3		2.2	2				
V _{OL}	I _{OL} = 100 µA	1.65 V to 3.6 V		0.1	0.2	0.3				V
	I _{OL} = 4 mA	1.65 V		0.24	0.45	0.6				
	I _{OL} = 8 mA	2.3 V		0.3	0.7	0.75				
	I _{OL} = 12 mA	2.7 V		0.4	0.4	0.6				
	I _{OL} = 24 mA	3 V		0.55	0.55	0.8				
I _I	V _I = 5.5 V or GND	3.6 V		±1	±5	±20	µA			
I _{CC}	V _I = V _{CC} or GND, I _O = 0	3.6 V		1	10	40	µA			
ΔI _{CC}	One input at V _{CC} − 0.6 V, Other inputs at V _{CC} or GND	2.7 V to 3.6 V		500	500	5000	µA			
C _i	V _I = V _{CC} or GND	3.3 V		5			pF			

SN54LVC14A, SN74LVC14A HEX SCHMITT-TRIGGER INVERTERS

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Switching Characteristics

over operating free-air temperature range (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC}	SN54LVC14A		UNIT	
				−55 TO 125°C			
				MIN	MAX		
t _{pd}	A	Y	2.7 V		7.5	ns	
			3.3 V ± 0.3 V	1	6.4		

Switching Characteristics

over operating free-air temperature range (unless otherwise noted) (see Figure 1)

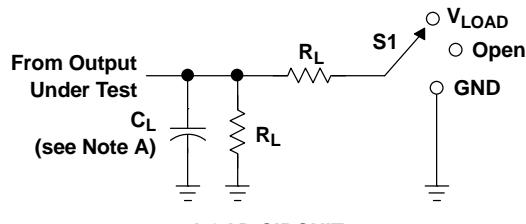
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC}	SN74LVC14A						UNIT	
				T _A = 25°C			−40 TO 85°C		−40 TO 125°C		
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{pd}	A	Y	1.8 V ± 0.15 V	1	5	10.5	1	11	1	13	ns
			2.5 V ± 0.2 V	1	3.4	7.3	1	7.8	1	10	
			2.7 V	1	3.6	7.3	1	7.5	1	9.5	
			3.3 V ± 0.3 V	1	3.2	6.2	1	6.4	1	8	
t _{sk(o)}			3.3 V ± 0.3 V			1		1		1.5	ns

Operating Characteristics

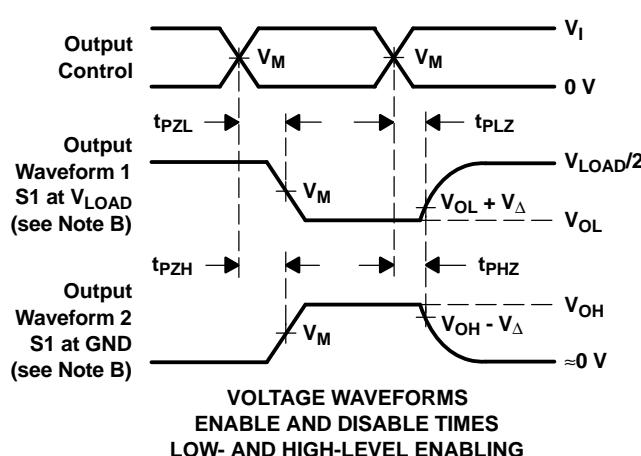
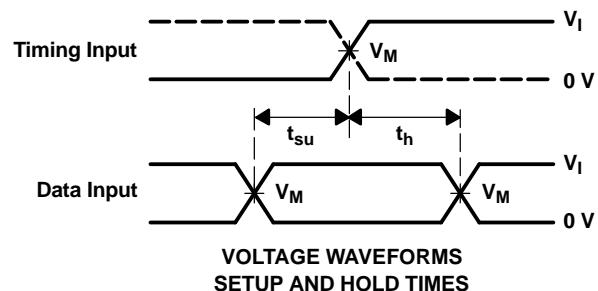
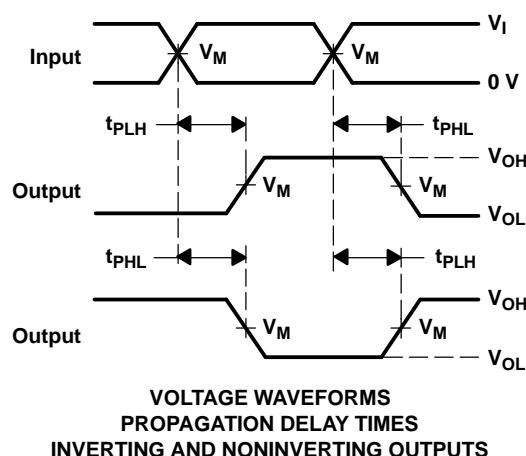
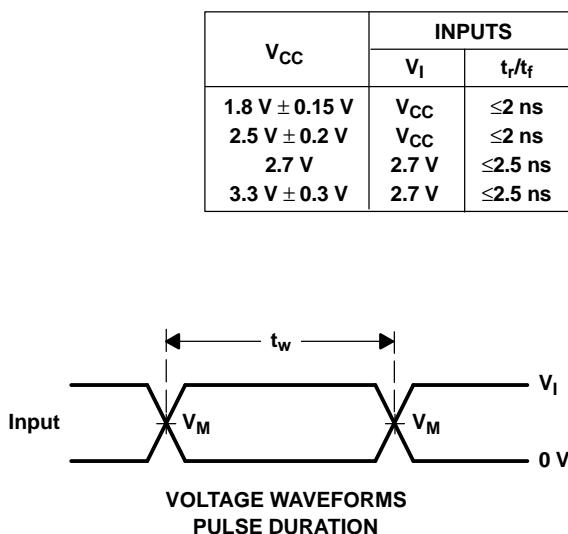
T_A = 25°C

PARAMETER			TEST CONDITIONS f = 10 MHz	V _{CC}	TYP	UNIT	
C _{pd}	Power dissipation capacitance per inverter			1.8 V	11	pF	
				2.5 V	12		
				3.3 V	15		

Parameter Measurement Information



TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	V_{LOAD}
t_{PHZ}/t_{PZH}	GND



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$.
 - D. The outputs are measured one at a time, with one transition per measurement.
 - E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - F. t_{PZL} and t_{PZH} are the same as t_{en} .
 - G. t_{PLH} and t_{PHL} are the same as t_{pd} .
 - H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-9761501Q2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
5962-9761501QCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
5962-9761501QDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
5962-9761501VCA	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
5962-9761501VDA	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC
SN74LVC14AD	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14ADBLE	OBsolete	SSOP	DB	14		TBD	Call TI	Call TI
SN74LVC14ADBR	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14ADBRE4	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14ADBRG4	ACTIVE	SSOP	DB	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1YEAR
SN74LVC14ADE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14ADG4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14ADGVR	ACTIVE	TVSOP	DGV	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14ADGVRE4	ACTIVE	TVSOP	DGV	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14ADR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14ADRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14ADRG4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14ADT	ACTIVE	SOIC	D	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14ADTE4	ACTIVE	SOIC	D	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14ANSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14ANSRG4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14APW	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14APWE4	ACTIVE	TSSOP	PW	14	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14APWLE	OBsolete	TSSOP	PW	14		TBD	Call TI	Call TI
SN74LVC14APWR	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14APWRE4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14APWRG4	ACTIVE	TSSOP	PW	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14APWT	ACTIVE	TSSOP	PW	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
no Sb/Br)								
SN74LVC14APWTE4	ACTIVE	TSSOP	PW	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14APWTG4	ACTIVE	TSSOP	PW	14	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LVC14ARGYR	ACTIVE	QFN	RGY	14	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1YEAR
SN74LVC14ARGYRG4	ACTIVE	QFN	RGY	14	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-2-260C-1YEAR
SNJ54LVC14AFK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LVC14AJ	ACTIVE	CDIP	J	14	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LVC14AW	ACTIVE	CFP	W	14	1	TBD	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

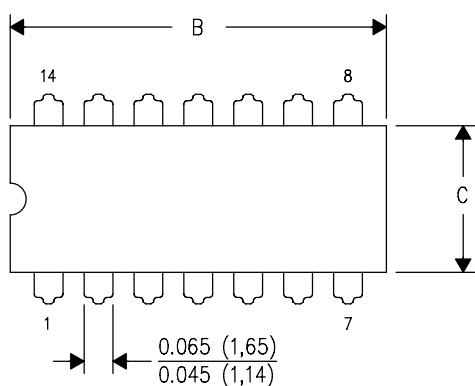
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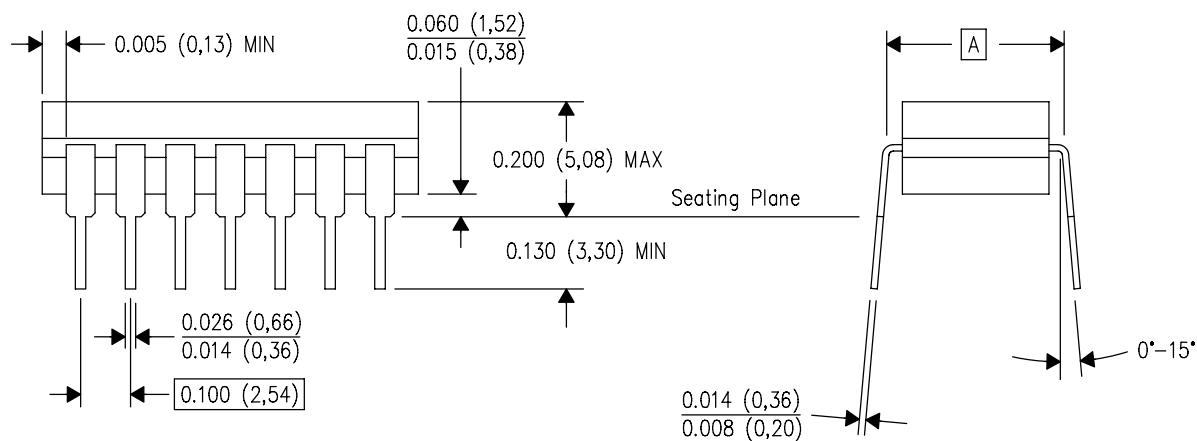
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



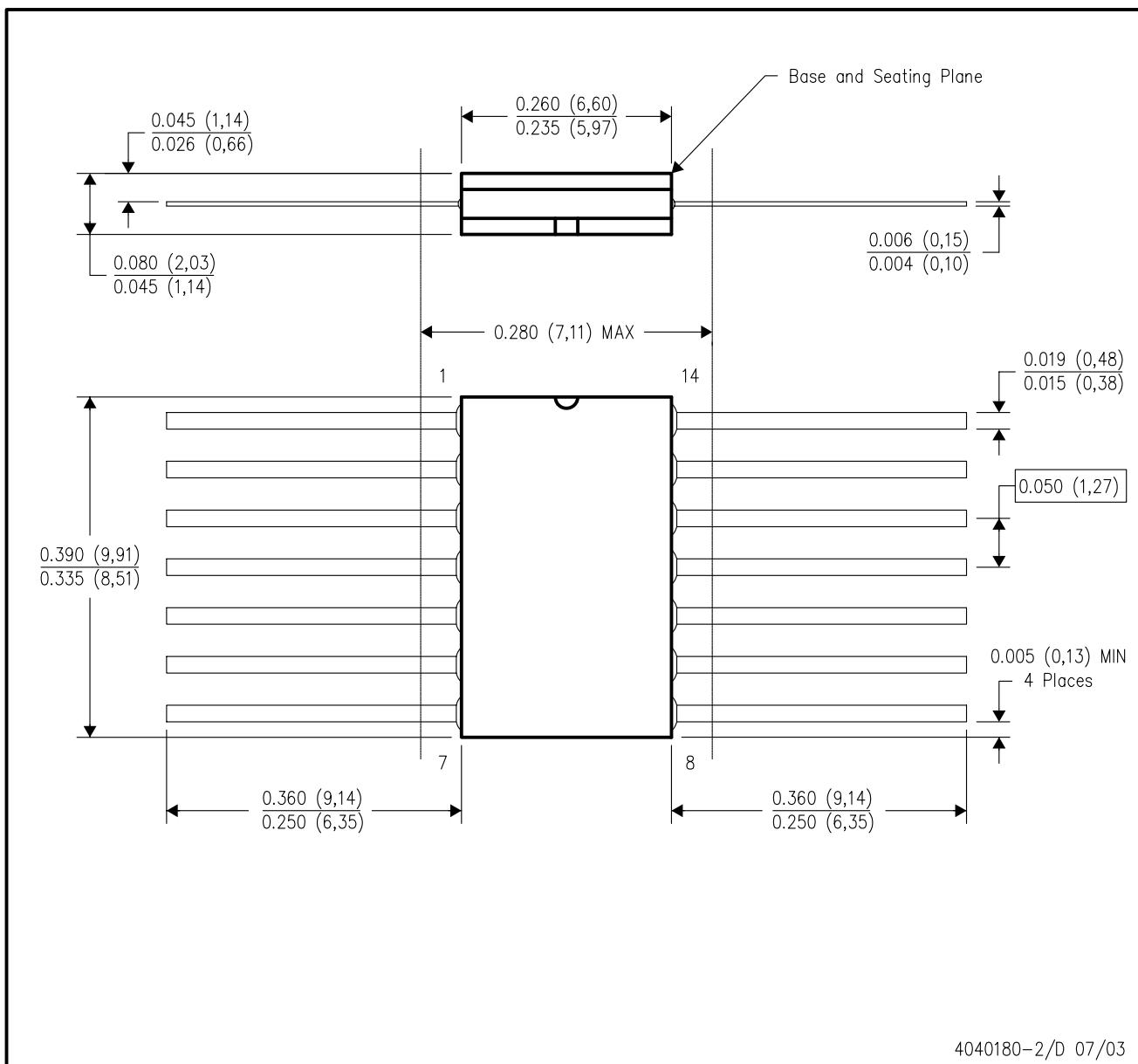
4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

MECHANICAL DATA

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB

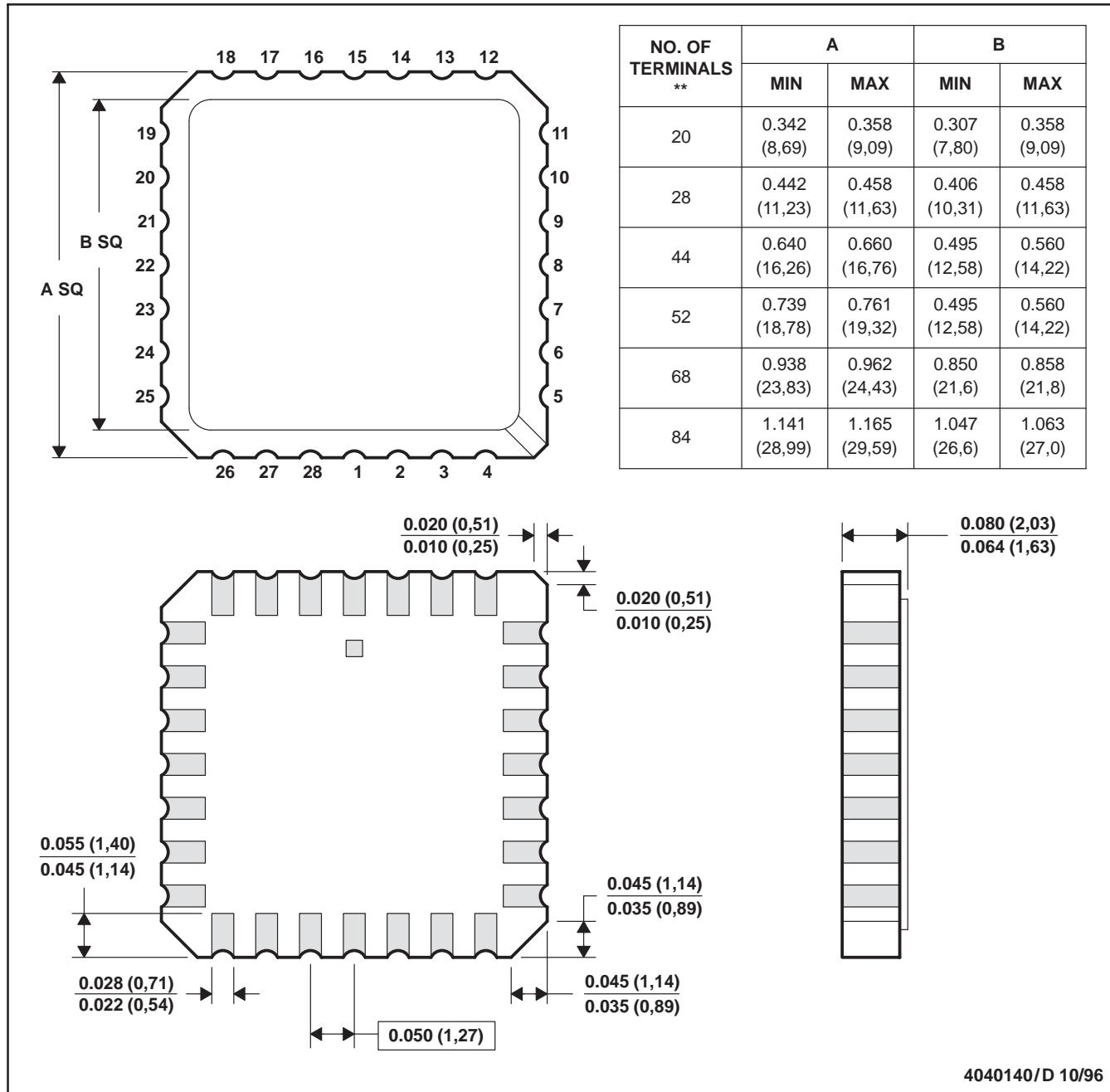
MECHANICAL DATA

MLCC006B – OCTOBER 1996

FK (S-CQCC-N)**

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



4040140/D 10/96

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a metal lid.
 - The terminals are gold plated.
 - Falls within JEDEC MS-004

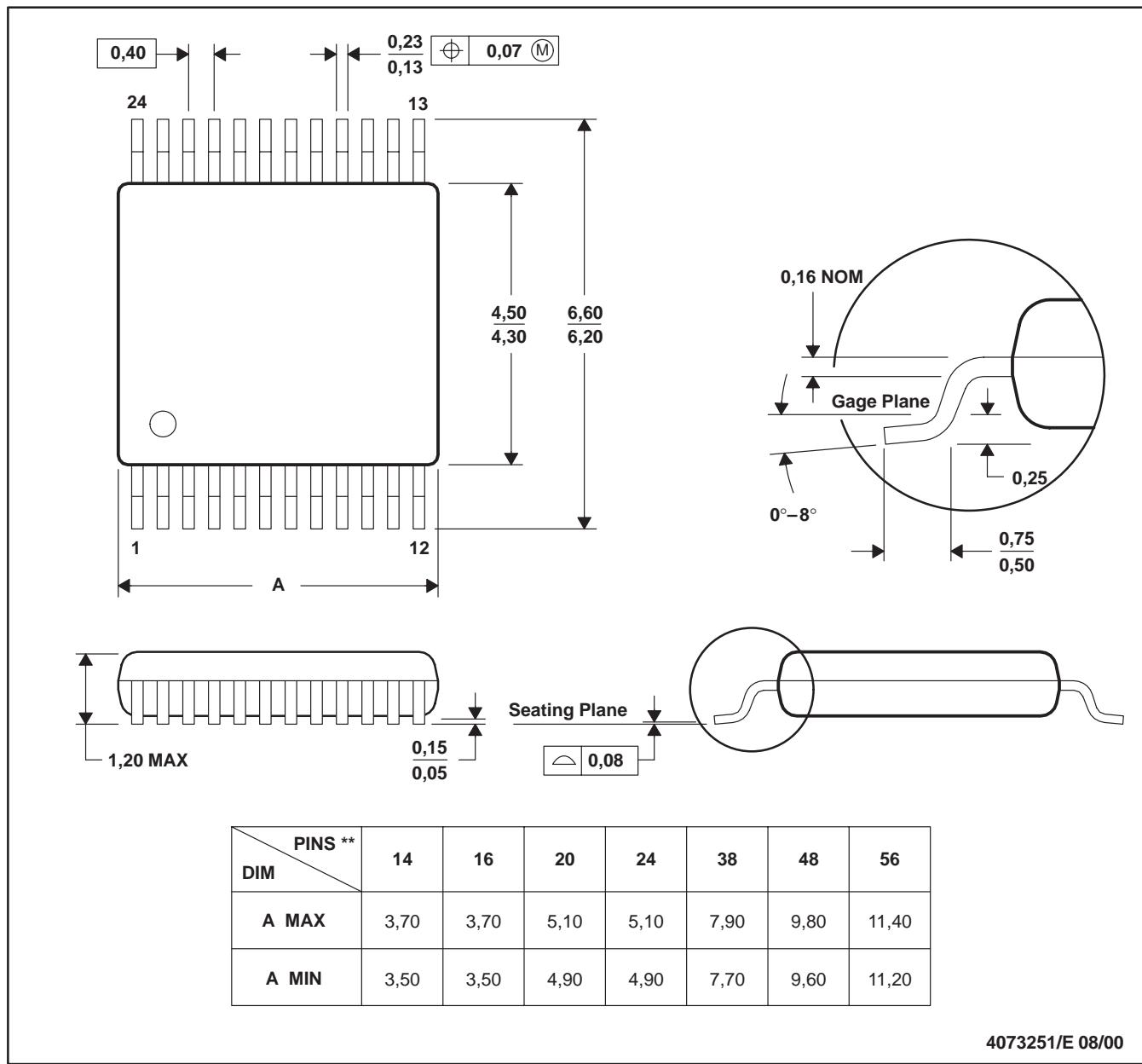
MECHANICAL DATA

MPDS006C – FEBRUARY 1996 – REVISED AUGUST 2000

DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE

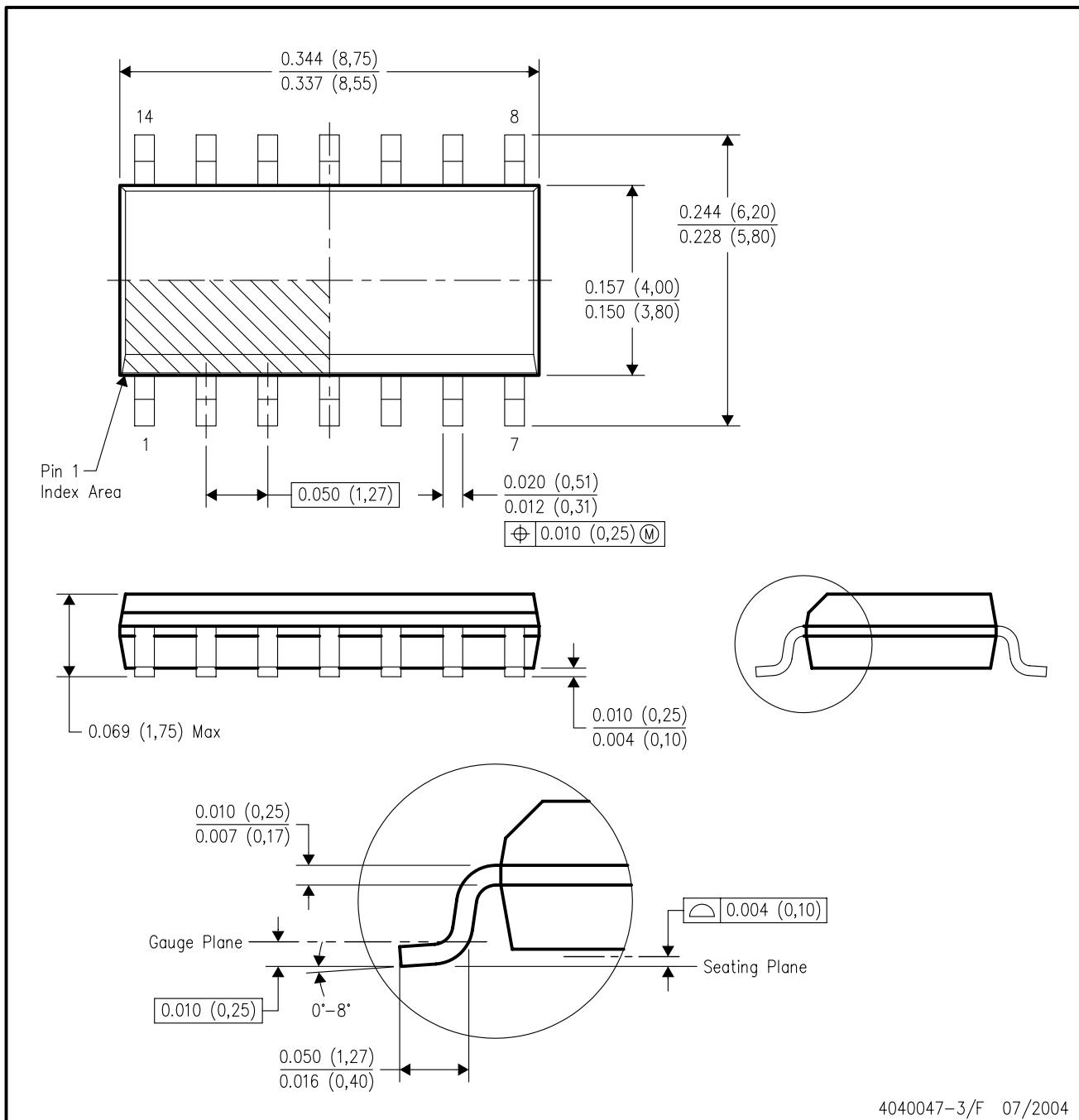


- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 - D. Falls within JEDEC: 24/48 Pins – MO-153
14/16/20/56 Pins – MO-194

MECHANICAL DATA

D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



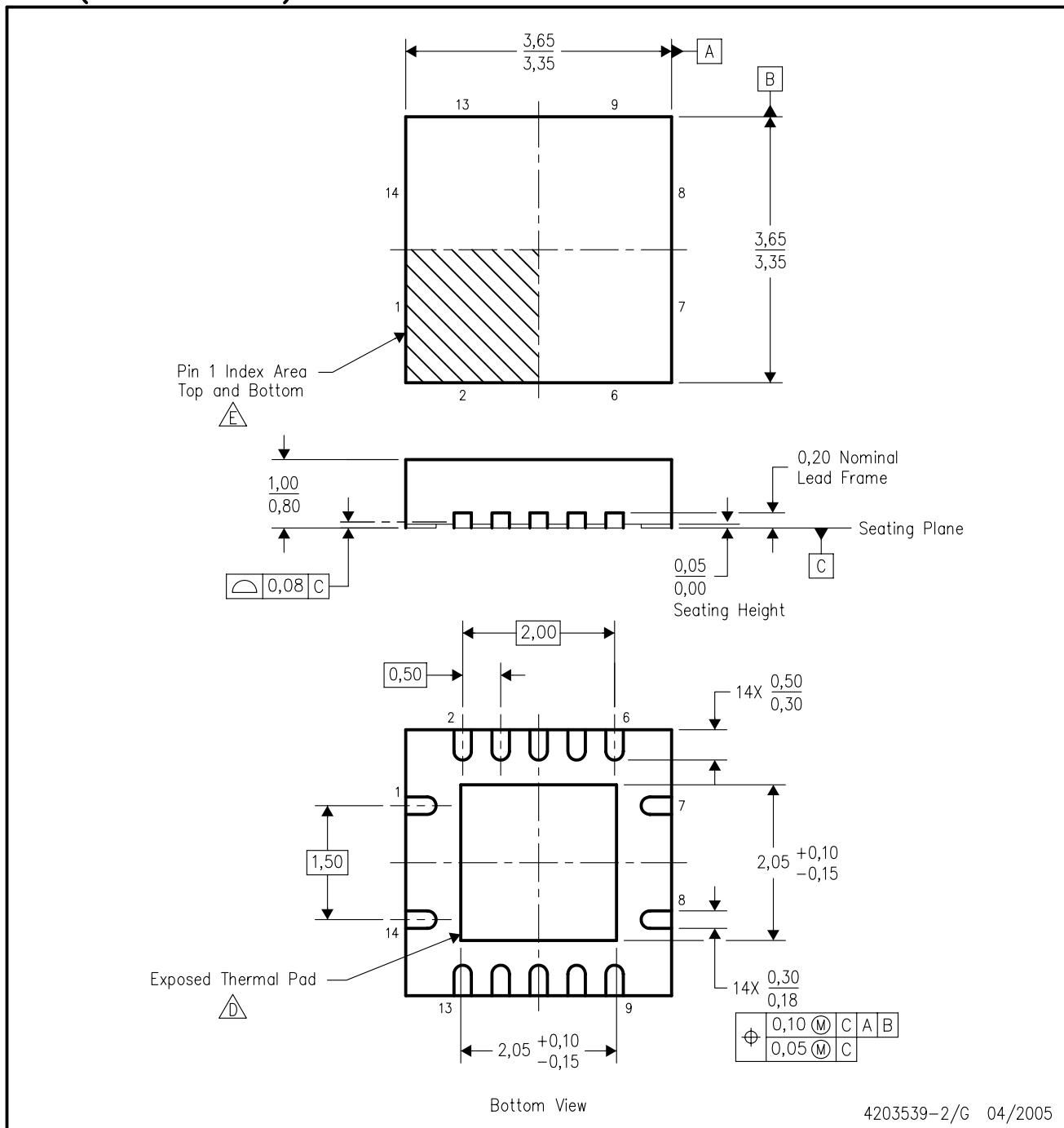
4040047-3/F 07/2004

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
 - Falls within JEDEC MS-012 variation AB.

MECHANICAL DATA

RGY (S-PQFP-N14)

PLASTIC QUAD FLATPACK

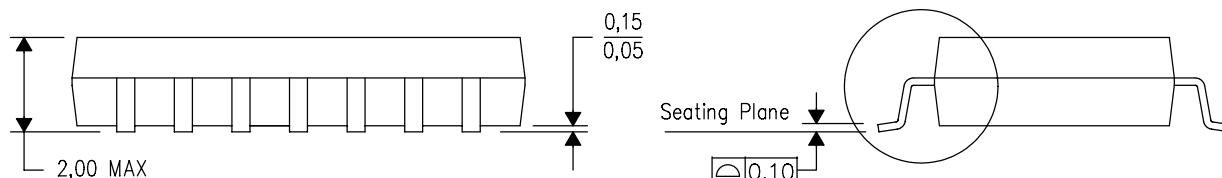
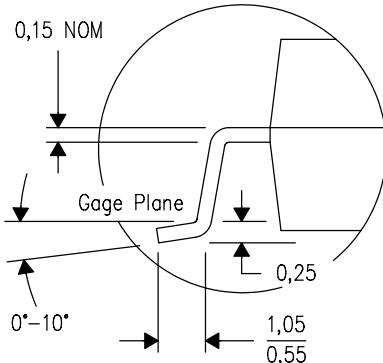
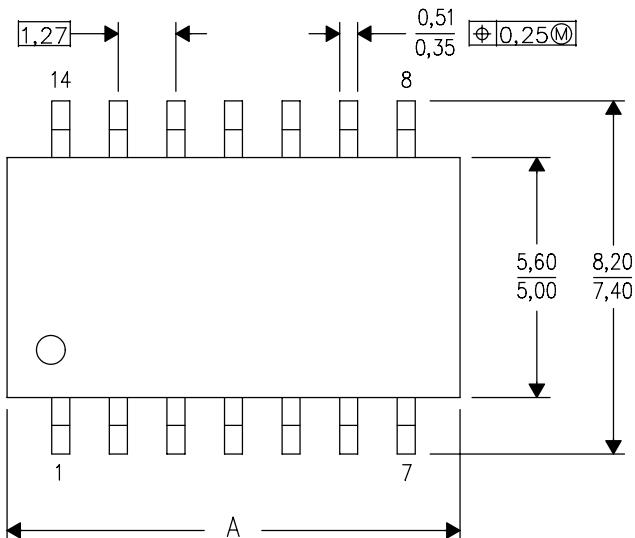


MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



PINS ** DIM	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

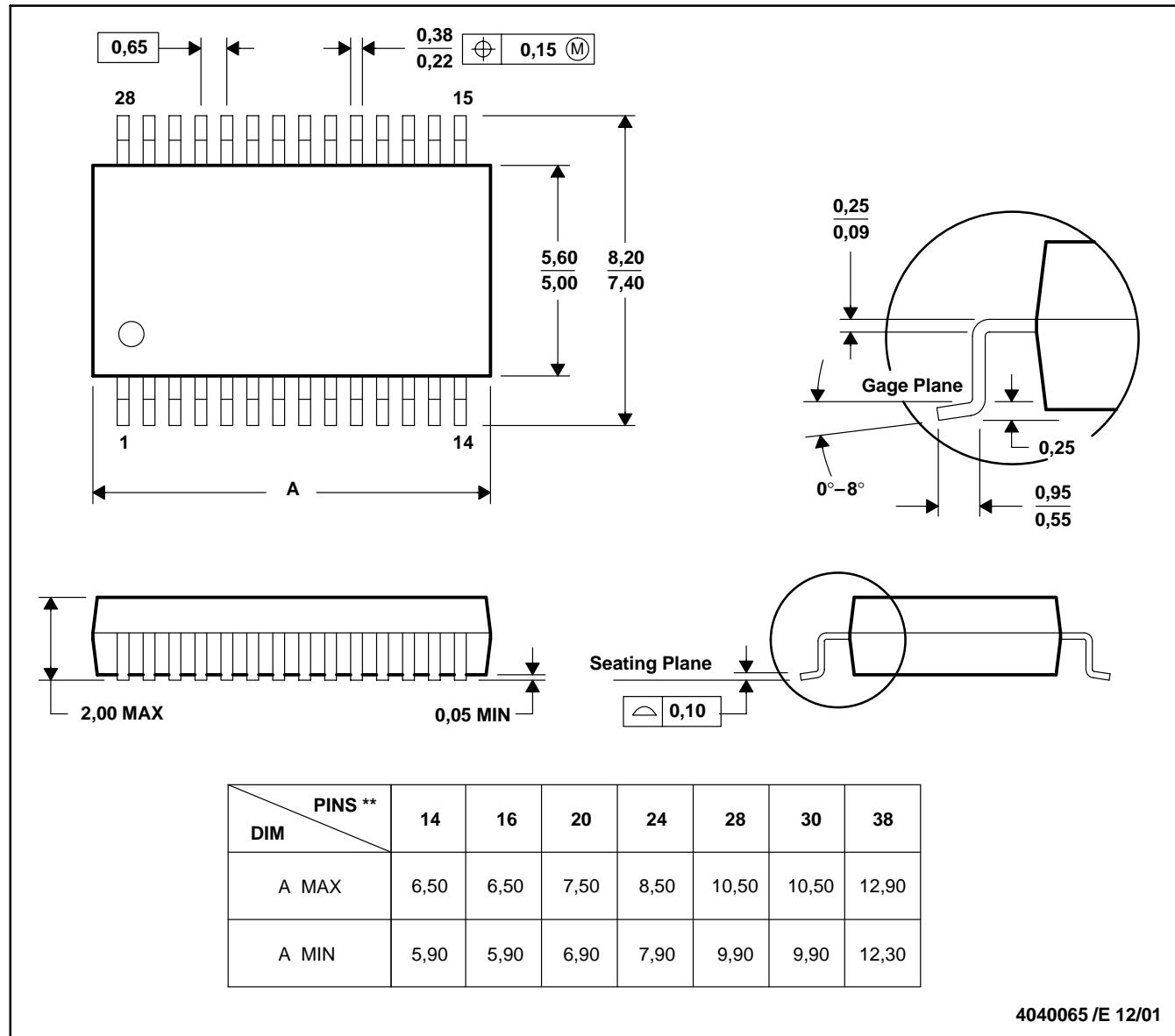
MECHANICAL DATA

MSS002E – JANUARY 1995 – REVISED DECEMBER 2001

DB (R-PDSO-G)**

28 PINS SHOWN

PLASTIC SMALL-OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 - D. Falls within JEDEC MO-150

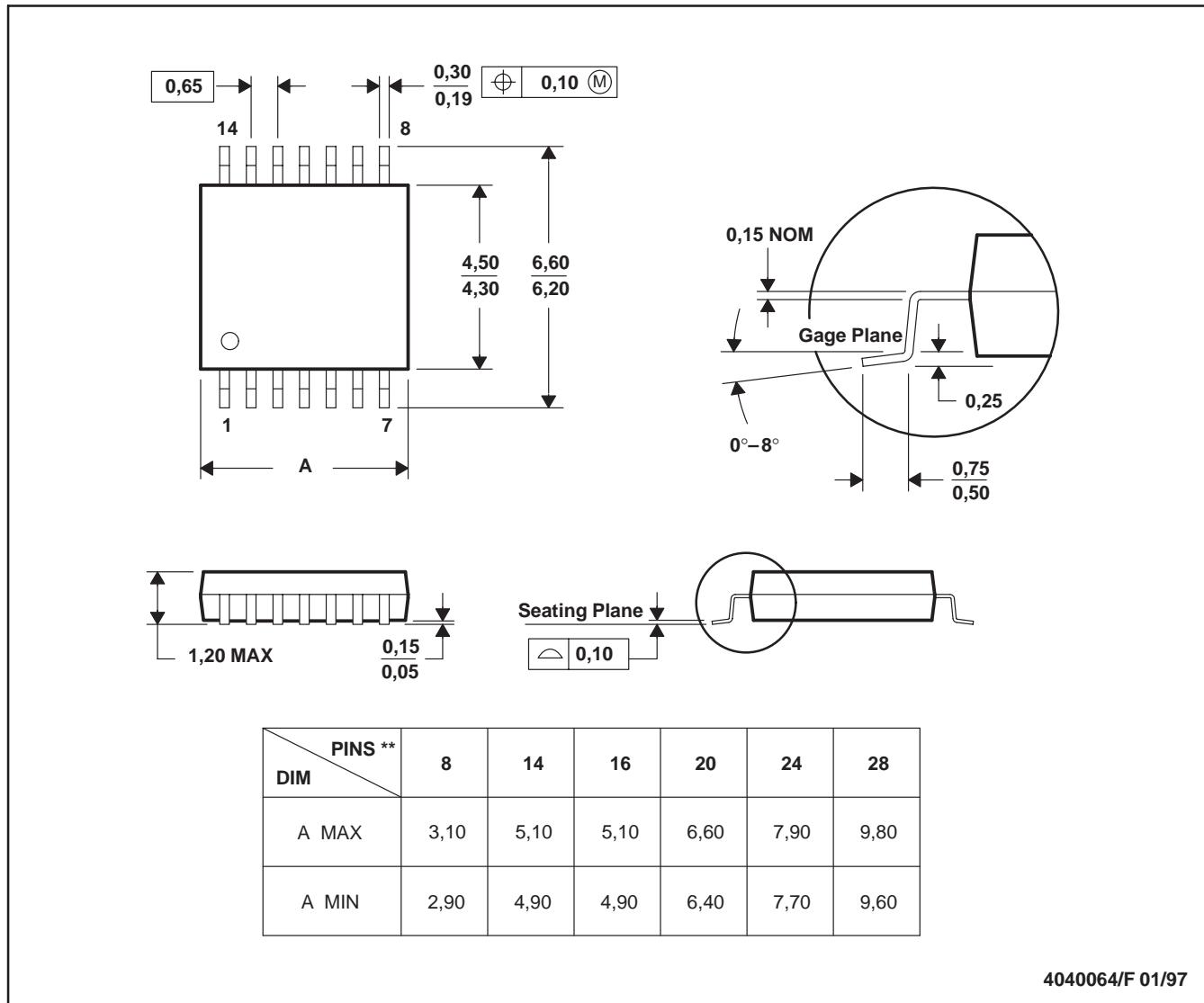
MECHANICAL DATA

MTSS001C – JANUARY 1995 – REVISED FEBRUARY 1999

PW (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion not to exceed 0,15.
 - Falls within JEDEC MO-153

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